Kingbright

2.0x1.25mm SMD CHIP LED LAMP

APT2012SGC SUPER BRIGHT GREEN

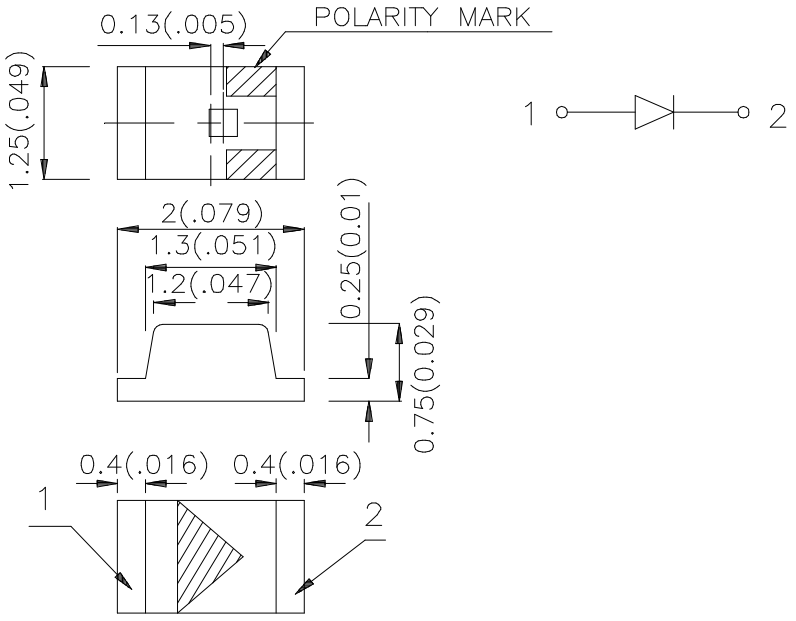
Features

- ●2.0mmx1.25mm SMT LED,0.75mm THICKNESS.
- ●LOW POWER CONSUMPTION.
- ●WIDE VIEWING ANGLE.
- ●IDEAL FOR BACKLIGHT AND INDICATOR.
- ●VARIOUS COLORS AND LENS TYPES AVAILABLE.
- ●PACKAGE : 2000PCS / REEL.
- ●RoHS COMPLIANT.

Description

The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions



Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.1(0.004") unless otherwise noted.
3. Specifications are subject to change without notice.

Kingbright

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) @ 20mA		Viewing Angle
			Min.	Typ.	2θ1/2
APT2012SGC	SUPER BRIGHT GREEN (GaP)	WATER CLEAR	4	15	120°

Note:
1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

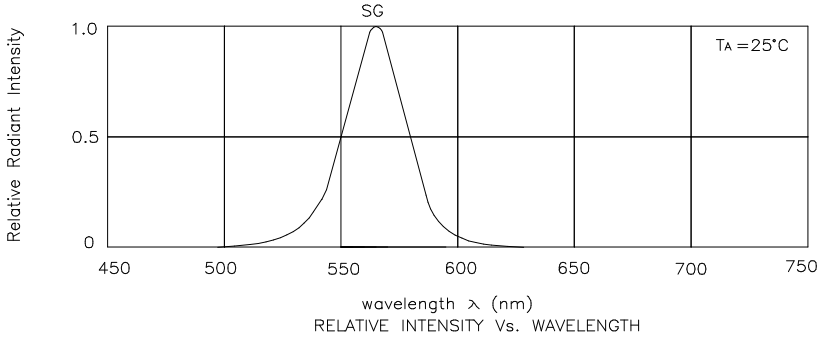
Electrical / Optical Characteristics at T_A=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Green	565		nm	I_F=20mA
λD	Dominant Wavelength	Super Bright Green	568		nm	I_F=20mA
Δλ1/2	Spectral Line Half-width	Super Bright Green	30		nm	I_F=20mA
C	Capacitance	Super Bright Green	15		pF	V_F=0V;f=1MHz
V_F	Forward Voltage	Super Bright Green	2.2	2.5	V	I_F=20mA
I_R	Reverse Current	Super Bright Green		10	uA	V_R= 5V

Absolute Maximum Ratings at T_A=25°C

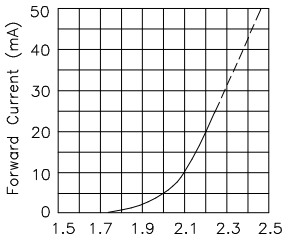
Parameter	Super Bright Green	Units
Power dissipation	105	mW
DC Forward Current	25	mA
Peak Forward Current [1]	140	mA
Reverse Voltage	5	V
Operating / Storage Temperature	-40°C To +85°C	

Note:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

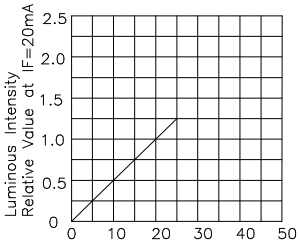


RELATIVE INTENSITY Vs. WAVELENGTH

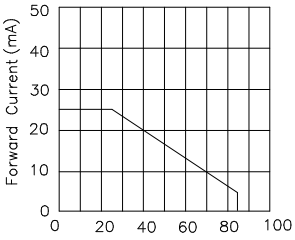
Super Bright Green **APT2012SGC**



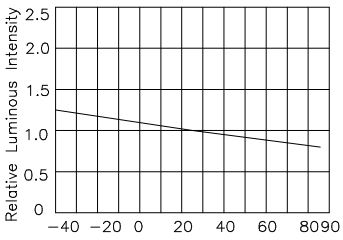
FORWARD CURRENT Vs.
FORWARD VOLTAGE



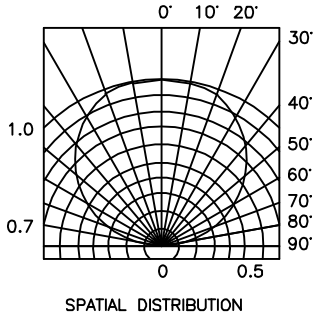
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE



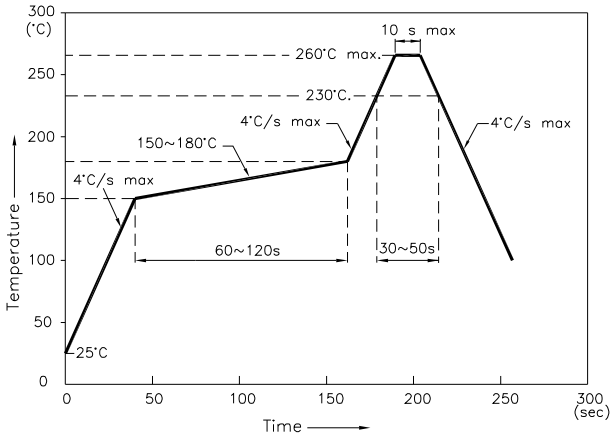
LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

APT2012SGC

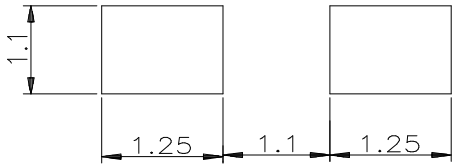
Reflow Soldering Profile For Lead-free SMT Process.



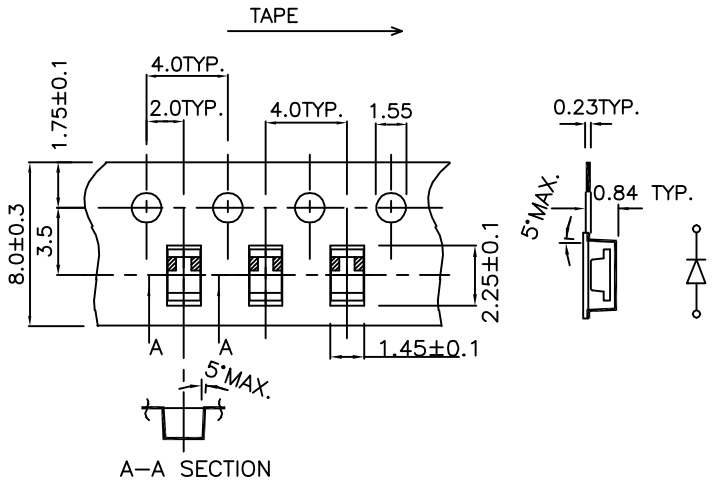
NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern
(Units : mm)



Tape Specifications
(Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.